

SOM Modules

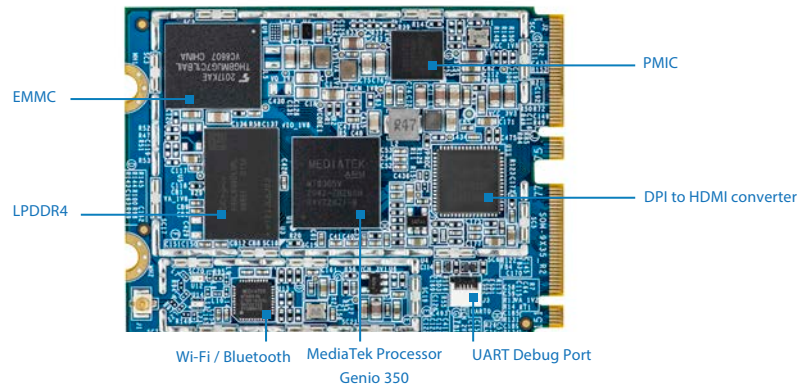
VIA SOM-3000

Fanless low-power platform for Edge AI applications with Quad-Core MediaTek Genio 350 SoC

Features

- High-performance MediaTek Genio 350 Quad-Core SoC
- Integrated AI processor for Edge AI applications
- Dual-band 802.11ac Wi-Fi with Bluetooth 5.0
- Dual display support
- Dual camera support

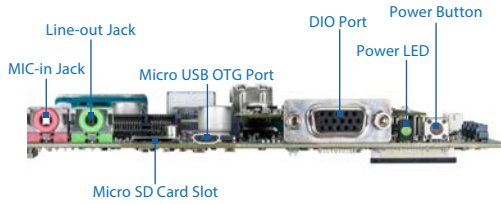
Board Placement



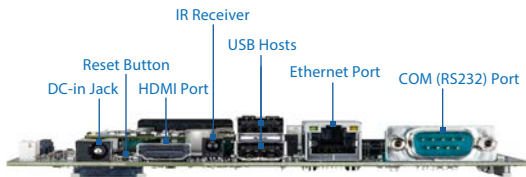
Specifications

Model Name	SOM-3000
Processor	2.0GHz MediaTek Genio 350 Cortex-A53 Quad-Core SoC
System Memory	2GB LPDDR4 SDRAM
Storage	16GB eMMC Flash Memory
Graphics	ARM Mali-G52 3EE MC1 GPU 3D graphics accelerator capable of processing 1600M pixel/sec @ 800MHz Graphics engine supporting OpenGL® ES 3.2, OpenCL ES 2.0, and Vulkan 1.1 hardware acceleration Supports H.265 and H.264 video decoding up to 1080p @ 60fps Supports Cadence Tensilica Vision P6 and HiFi4
Wireless Connectivity	MediaTek MT6631 Dual band (2.4GHz & 5GHz) single stream Wi-Fi 802.11 a/b/g/n/ac RF Bluetooth 5.0
PMIC/Audio Codec	MediaTek MT6357/MT6390
HDMI	Lontium LT8618SXB Digital Parallel Interface to HDMI 1.4 transmitter
Supported I/O through Golden Finger	1 4-Lane MIPI DSI 2 4-Lane MIPI CSI 1 HDMI 1.4 1 USB 2.0 Host 1 USB 2.0 OTG 1 SPI 3 I2C 2 UART 2 MIC-in 1 Line-out 1 ADC 1 SDIO 3.0 6 GPIO 2 PWM 1 Battery Gas Gauge 1 3.4 ~ 4.2V DC-in
Onboard I/O	1 RF I-PEX (for RF antenna for Wi-Fi and Bluetooth) 1 Debug UART (for USB to UART debug board)
Operating System	Android 12, Yocto 3.1
Operating Temperature	0°C ~ 60°C
Operating Humidity	0% ~ 95% (relative humidity ; non-condensing)
PCBA Form Factor	60mm x 45mm
Top heat spreader size	50mm x 32mm
Bottom heat spreader size	48mm x 43mm
Dimensions (with two-sided heat spreader)	60mm x 45mm x 6.8mm (W x D x H)

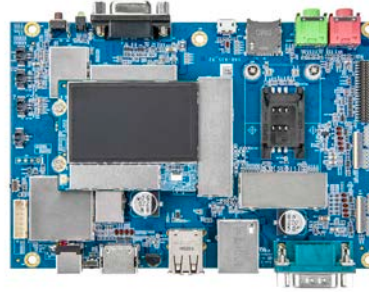
VAB-935 Carrier Board Front Panel I/O



VAB-935 Carrier Board Back Panel I/O



VAB-935 Carrier Board



Specifications

Model Name	VAB-935 Carrier Board
USB	Genesys GL852GT-MNG USB 2.0 MTT HUB
LAN	Realtek RTL8152BNI-VB-CG USB 2.0 to 10/100M Ethernet controller
Onboard I/O	<ul style="list-style-type: none"> 2 4-lane MIPI CSI connectors 1 4-lane MIPI DSI connector 1 Capacitive touch panel connector 1 RTC battery connector 1 Battery charger connector 1 miniPCIe slot for 4G with GNSS 1 SIM card slot 1 Download button 1 MIC connector 2 Speaker connectors 1 MCU upgrade connector 1 I/O expansion connector (supports GPIO x 5, I2C x1, UART x1, SPI x1, PWM x 2, ADC x 1 from SOM-3000, and GPIO x 11 from Expander IC) 2 M.2 connectors for VIA SOM-3000 module
Front Panel I/O	<ul style="list-style-type: none"> 1 Micro USB 2.0 OTG port 1 DIO port supporting 10 GPIO with 3.3V power 1 Micro SD card slot 2 Audio jacks : Line-out and MIC-in 1 Power LED 1 Power button
Back Panel I/O	<ul style="list-style-type: none"> 1 HDMI port (supports 720p @ 60Hz) 2 USB 2.0 ports 1 COM port for RS232 (TX/RX) 1 10/100Mbps Ethernet port 1 DC-in jack 1 Reset Button 1 IR Receiver
Power Supply	<ul style="list-style-type: none"> 12V DC-in (support 9V~15V) 2-cell 8.4V Lion battery (optional)
Operation System	Android 12, Yocto 3.1
Operating Temperature	0°C ~ 60°C
Operating Humidity	0% ~ 95% (relative humidity ; non-condensing)
Form Factor	3.5" SBC, 14.6cm x 10.2cm (5.75" x 4.02")
Compliance	CE, FCC, UKCA

Ordering Information

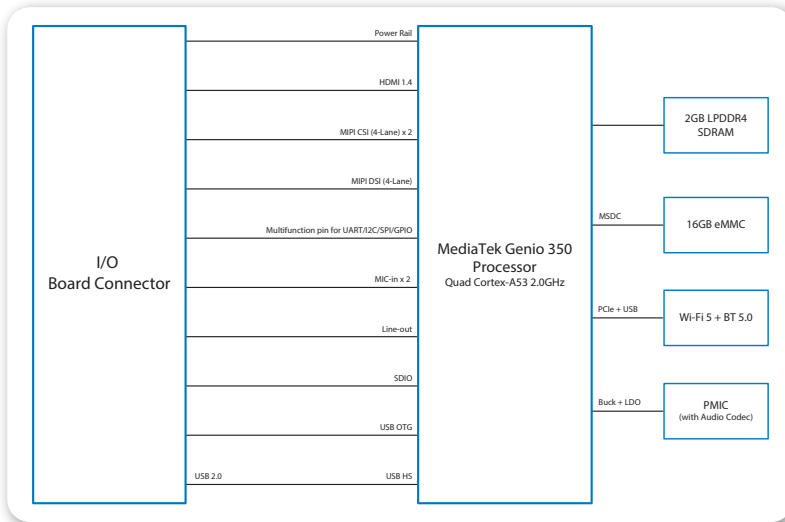
Part Number	SoC Frequency	Description
10GPE20G10020A0	MediaTek Genio 350 Quad-Core SoC @ 2.0GHz	VIA SOM-3000 module with 2.0GHz MediaTek Genio 350 Quad-Core SoC, 16GB eMMC, 2GB LPDDR4 SDRAM, Wi-Fi 5, Bluetooth 5.0
STK-SOM935-00A0		VIA SOM-3000 starter kit with VIA SOM-3000 module, VIA VAB-935 carrier board + accessory kit

Optional Accessories

Wireless Module Options

Part Number	Description
EMIO-2575-00A0	4G LTE mobile broadband miniPCIe module with two antennas and assembly (Japan only)

Block Diagram



Starter Kit Packing List

Items

- VIA SOM-3000 module
- VIA VAB-935 carrier board
- 7" 1024x600 MIPI LCD + touch panel display
- 2.4G/5G Wi-Fi antenna
- 4 PIN FFC cable
- 13MP CMOS sensor camera module
- 2 x 2W Speakers
- Microphone
- 3V, 240mAh RTC battery
- USB to UART debug board
- 12V 3A AC Adapter